# 74HC154; 74HCT154

### 4-to-16 line decoder/demultiplexer

Rev. 8 — 11 May 2021

**Product data sheet** 

### 1. General description

The 74HC154; 74HCT154 is a 4-to-16 line decoder/demultiplexer. It decodes four binary weighted address inputs (A0 to A3) to sixteen mutually exclusive outputs ( $\overline{Y0}$  to  $\overline{Y15}$ ). The device features two input enable ( $\overline{E0}$  and  $\overline{E1}$ ) inputs. A HIGH on either of the input enables forces the outputs HIGH. The device can be used as a 1-to-16 demultiplexer by using one of the enable inputs as the multiplexed data input. When the other enable input is LOW the addressed output will follow the state of the applied data. Inputs include clamp diodes. This enables the use of current limiting resistors to interface inputs to voltages in excess of  $V_{CC}$ .

### 2. Features and benefits

- 16-line demultiplexing capability
- Decodes 4 binary-coded inputs into 16 mutually-exclusive outputs
- Complies with JEDEC standard no. 7A
- Input levels:
  - For 74HC154: CMOS level
  - For 74HCT154: TTL level
- ESD protection:
  - HBM JESD22-A114F exceeds 2000 V
  - MM JESD22-A115-A exceeds 200 V
- Multiple package options
- Specified from -40 °C to +85 °C and -40 °C to +125 °C

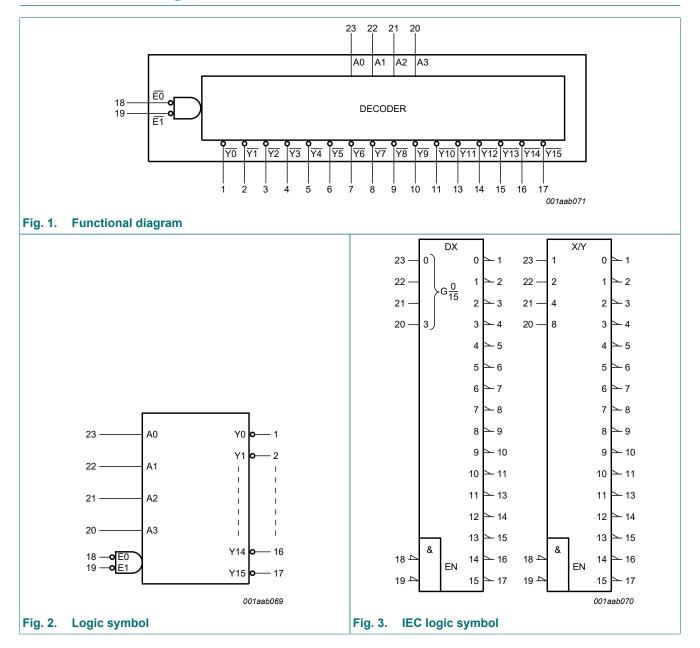
### 3. Ordering information

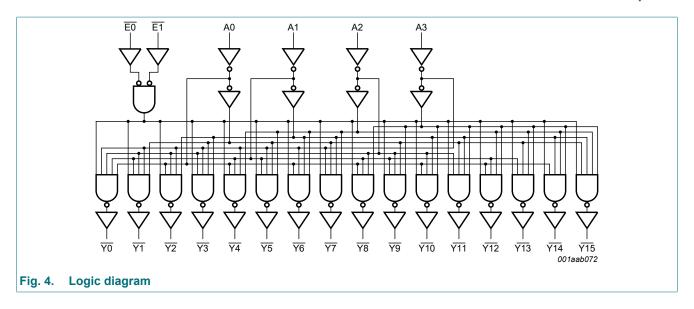
**Table 1. Ordering information** 

Type number	Package			
	Temperature range	Name	Description	Version
74HC154D	-40 °C to +125 °C	SO24	plastic small outline package; 24 leads; body width 7.5 mm	SOT137-1
74HCT154D	_			
74HC154DB	-40 °C to +125 °C	SSOP24	plastic shrink small outline package; 24 leads; body width 5.3 mm	SOT340-1
74HC154PW	-40 °C to +125 °C	TSSOP24	plastic thin shrink small outline package; 24 leads;	SOT355-1
74HCT154PW			body width 4.4 mm	
74HC154BQ	-40 °C to +125 °C	DHVQFN24	plastic dual in-line compatible thermal enhanced	SOT815-1
74HCT154BQ	-		very thin quad flat package; no leads; 24 terminals; body 3.5 × 5.5 × 0.85 mm	



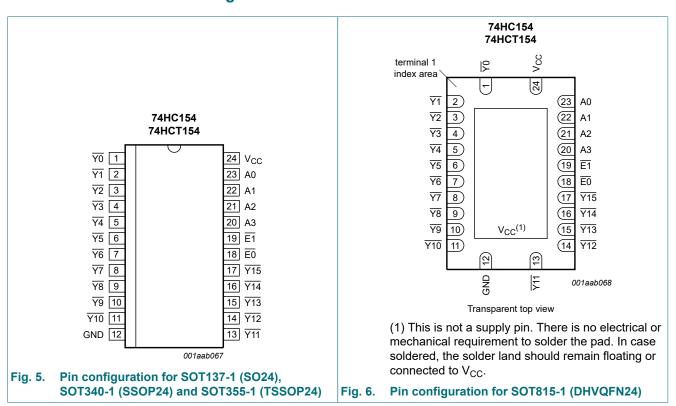
### 4. Functional diagram





### 5. Pinning information

### 5.1. Pinning



### 5.2. Pin description

Table 2. Pin description

Symbol	Pin	Description											
Y0, Y1, Y2, Y3, Y4, Y5, Y6, Y7,         Y8, Y9, Y10, Y11, Y12, Y13, Y14, Y15	1, 2, 3, 4, 5, 6, 7, 8, 9, 10, 11, 13, 14, 15, 16, 17	data output (active LOW)											
GND	12	ground (0 V)											
E0, E1	18, 19	enable input (active LOW)											
A0, A1, A2, A3	23, 22, 21, 20	address input											
V <sub>CC</sub>	24	supply voltage											

### 6. Functional description

### **Table 3. Function table**

 $H = HIGH \ voltage \ level; \ L = LOW \ voltage \ level; \ X = don't \ care.$ 

		Inp	out										(	Outpu	t						
ΕO	E1	A0	<b>A</b> 1	A2	А3	<u>Y0</u>	<u>Y1</u>	<u>Y2</u>	<u></u> 73	<u>¥4</u>	<u>Y5</u>	<u>Y6</u>	<u> 77</u>	<u> 78</u>	<u>Y9</u>	Y10	<u>Y11</u>	<u>Y12</u>	<u>Y13</u>	<u>Y14</u>	Y15
Н	Н	Χ	Χ	Χ	Χ	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н
Н	L	Χ	Χ	Χ	Χ	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н
L	Н	Χ	Χ	Χ	Χ	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н
L	L	L	L	L	L	L	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н
		Н	L	L	L	Н	L	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н
		L	Н	L	L	Н	Н	L	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н
		Н	Н	L	L	Н	Н	Н	L	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н
		L	L	Н	L	Н	Н	Н	Н	L	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н
		Н	L	Н	L	Н	Н	Н	Н	Н	L	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н
		L	Н	Н	L	Н	Н	Н	Н	Н	Н	L	Н	Н	Н	Н	Н	Н	Н	Н	Н
		Н	Н	Н	L	Н	Н	Н	Н	Н	Н	Н	L	Н	Н	Н	Н	Н	Н	Н	Н
		L	L	L	Н	Н	Н	Н	Н	Н	Н	Н	Н	L	Н	Н	Н	Н	Н	Н	Н
		Н	L	L	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	L	Н	Н	Н	Н	Н	Н
		L	Н	L	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	L	Н	Н	Н	Н	Н
		Н	Н	L	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	L	Н	Н	Н	Н
		L	L	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	L	Н	Н	Н
		Н	L	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	L	Н	Н
		L	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	L	Н
		Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	L

### 7. Limiting values

#### **Table 4. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		Min	Max	Unit
V <sub>CC</sub>	supply voltage			-0.5	+7.0	V
I <sub>IK</sub>	input clamping current	$V_{I} < -0.5 \text{ V or } V_{I} > V_{CC} + 0.5 \text{ V}$	[1]	-	±20	mA
I <sub>OK</sub>	output clamping current	$V_{O}$ < -0.5 V or $V_{O}$ > $V_{CC}$ + 0.5 V	[1]	-	±20	mA
lo	output current	$-0.5 \text{ V} < \text{V}_{\text{O}} < \text{V}_{\text{CC}} + 0.5 \text{ V}$	[1]	-	±25	mA
I <sub>CC</sub>	supply current		[1]	-	50	mA
I <sub>GND</sub>	ground current		[1]	-	-50	mA
T <sub>stg</sub>	storage temperature			-65	+150	°C
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> = -40 °C to +125 °C	[2]	-	500	mW

<sup>[1]</sup> The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

For SOT340-1 (SSOP24) packages: P<sub>tot</sub> derates linearly with 12.4 mW/K above 110 °C.

For SOT355-1 (TSSOP24) package: Ptot derates linearly with 12.4 mW/K above 110 °C.

For SOT815-1 (DHVQFN24) package: Ptot derates linearly with 15.0 mW/K above 117 °C.

### 8. Recommended operating conditions

#### Table 5. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V)

Symbol	Parameter	Conditions		74HC154	Į.	7	Unit		
			Min	Тур	Max	Min	Тур	Max	
$V_{CC}$	supply voltage		2.0	5.0	6.0	4.5	5.0	5.5	V
VI	input voltage		0	-	V <sub>CC</sub>	0	-	V <sub>CC</sub>	V
Vo	output voltage		0	-	V <sub>CC</sub>	0	-	V <sub>CC</sub>	V
T <sub>amb</sub>	ambient temperature		-40	+25	+125	-40	+25	+125	°C
Δt/ΔV	input transition rise and fall rate	V <sub>CC</sub> = 2.0 V	-	-	625	-	-	-	ns/V
		V <sub>CC</sub> = 4.5 V	-	1.67	139	-	1.67	139	ns/V
		V <sub>CC</sub> = 6.0 V	-	-	83	-	-	-	ns/V

<sup>[2]</sup> For SOT137-1 (SO24) package: Ptot derates linearly with 16.2 mW/K above 119 °C.

### 9. Static characteristics

#### Table 6. Static characteristics 74HC154

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbo	ol Parameter Conditions		Min	Тур	Max	Unit
T <sub>amb</sub> = 2	25 °C					
V <sub>IH</sub>	HIGH-level input voltage	V <sub>CC</sub> = 2.0 V	1.5	1.2	-	V
		V <sub>CC</sub> = 4.5 V	3.15	2.4	-	V
		V <sub>CC</sub> = 6.0 V	4.2	3.2	-	V
V <sub>IL</sub>	LOW-level input voltage	V <sub>CC</sub> = 2.0 V	-	0.8	0.5	V
		V <sub>CC</sub> = 4.5 V	-	2.1	1.35	V
		V <sub>CC</sub> = 6.0 V	-	2.8	1.8	V
V <sub>OH</sub>	HIGH-level output voltage	$V_I = V_{IH}$ or $V_{IL}$				
		V <sub>CC</sub> = 2.0 V; I <sub>O</sub> = -20 μA	1.9	2.0	-	V
		V <sub>CC</sub> = 4.5 V; I <sub>O</sub> = -20 μA	4.4	4.5	-	V
		V <sub>CC</sub> = 6.0 V; I <sub>O</sub> = -20 μA	5.9	6.0	-	V
		$V_{CC} = 4.5 \text{ V}; I_{O} = -4.0 \text{ mA}$	3.98	4.32	-	V
		V <sub>CC</sub> = 6.0 V; I <sub>O</sub> = -5.2 mA	5.48	5.81	-	V
V <sub>OL</sub>	LOW-level output voltage	$V_I = V_{IH}$ or $V_{IL}$				
		V <sub>CC</sub> = 2.0 V; I <sub>O</sub> = 20 μA	-	0	0.1	V
		V <sub>CC</sub> = 4.5 V; I <sub>O</sub> = 20 μA	-	0	0.1	V
		$V_{CC} = 6.0 \text{ V}; I_{O} = 20 \mu\text{A}$	-	0	0.1	V
		$V_{CC} = 4.5 \text{ V}; I_{O} = 4.0 \text{ mA}$	-	0.15	0.26	V
		$V_{CC} = 6.0 \text{ V}; I_{O} = 5.2 \text{ mA}$	-	0.16	0.26	V
I <sub>I</sub>	input leakage current	$V_{CC} = 6.0 \text{ V}; V_I = V_{CC} \text{ or GND}$	-	-	±0.1	μA
I <sub>CC</sub>	supply current	$V_{CC} = 6.0 \text{ V}; V_{I} = V_{CC} \text{ or GND}; I_{O} = 0 \text{ A}$	-	-	8.0	μA
Cı	input capacitance		-	3.5	-	pF
T <sub>amb</sub> =	-40 °C to +85 °C		·			
$V_{IH}$	HIGH-level input voltage	V <sub>CC</sub> = 2.0 V	1.5	-	-	V
		V <sub>CC</sub> = 4.5 V	3.15	-	-	V
		V <sub>CC</sub> = 6.0 V	4.2	-	-	V
$V_{IL}$	LOW-level input voltage	V <sub>CC</sub> = 2.0 V	-	-	0.5	V
		V <sub>CC</sub> = 4.5 V	-	-	1.35	V
		V <sub>CC</sub> = 6.0 V	-	-	1.8	V
V <sub>OH</sub>	HIGH-level output voltage	$V_I = V_{IH}$ or $V_{IL}$				
		V <sub>CC</sub> = 2.0 V; I <sub>O</sub> = -20 μA	1.9	-	-	V
		V <sub>CC</sub> = 4.5 V; I <sub>O</sub> = -20 μA	4.4	-	-	V
		V <sub>CC</sub> = 6.0 V; I <sub>O</sub> = -20 μA	5.9	-	-	V
		$V_{CC} = 4.5 \text{ V}; I_{O} = -4.0 \text{ mA}$	3.84	-	-	V
		$V_{CC}$ = 6.0 V; $I_{O}$ = -5.2 mA	5.34	-	-	V

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>OL</sub>	LOW-level output voltage	$V_I = V_{IH}$ or $V_{IL}$				
		V <sub>CC</sub> = 2.0 V; I <sub>O</sub> = 20 μA	-	-	0.1	V
		V <sub>CC</sub> = 4.5 V; I <sub>O</sub> = 20 μA	-	-	0.1	V
		V <sub>CC</sub> = 6.0 V; I <sub>O</sub> = 20 μA	-	-	0.1	V
		V <sub>CC</sub> = 4.5 V; I <sub>O</sub> = 4.0 mA	-	-	0.33	V
		V <sub>CC</sub> = 6.0 V; I <sub>O</sub> = 5.2 mA	-	-	0.33	V
l <sub>l</sub>	input leakage current	$V_{CC}$ = 6.0 V; $V_{I}$ = $V_{CC}$ or GND	-	-	±1.0	μA
I <sub>CC</sub>	supply current	$V_{CC} = 6.0 \text{ V}; V_{I} = V_{CC} \text{ or GND}; I_{O} = 0 \text{ A}$	-	-	80	μΑ
T <sub>amb</sub> = -4	40 °C to +125 °C		<u> </u>			_
V <sub>IH</sub>	HIGH-level input voltage	V <sub>CC</sub> = 2.0 V	1.5	-	-	V
		V <sub>CC</sub> = 4.5 V	3.15	-	-	V
		V <sub>CC</sub> = 6.0 V	4.2	-	-	V
V <sub>IL</sub>	LOW-level input voltage	V <sub>CC</sub> = 2.0 V	-	-	0.5	V
		V <sub>CC</sub> = 4.5 V	-	-	1.35	V
		V <sub>CC</sub> = 6.0 V	-	-	1.8	V
V <sub>OH</sub>	HIGH-level output voltage	$V_I = V_{IH}$ or $V_{IL}$				
		V <sub>CC</sub> = 2.0 V; I <sub>O</sub> = -20 μA	1.9	-	-	V
		V <sub>CC</sub> = 4.5 V; I <sub>O</sub> = -20 μA	4.4	-	-	V
		V <sub>CC</sub> = 6.0 V; I <sub>O</sub> = -20 μA	5.9	-	-	V
		$V_{CC} = 4.5 \text{ V}; I_{O} = -4.0 \text{ mA}$	3.7	-	-	V
		$V_{CC} = 6.0 \text{ V}; I_{O} = -5.2 \text{ mA}$	5.2	-	-	V
$V_{OL}$	LOW-level output voltage	$V_I = V_{IH}$ or $V_{IL}$				
		V <sub>CC</sub> = 2.0 V; I <sub>O</sub> = 20 μA	-	-	0.1	V
		V <sub>CC</sub> = 4.5 V; I <sub>O</sub> = 20 μA	-	-	0.1	V
		V <sub>CC</sub> = 6.0 V; I <sub>O</sub> = 20 μA	-	-	0.1	V
		V <sub>CC</sub> = 4.5 V; I <sub>O</sub> = 4.0 mA	-	-	0.4	V
		V <sub>CC</sub> = 6.0 V; I <sub>O</sub> = 5.2 mA	-	-	0.4	V
I <sub>I</sub>	input leakage current	$V_{CC}$ = 6.0 V; $V_{I}$ = $V_{CC}$ or GND	-	-	±0.1	μA
I <sub>CC</sub>	supply current	$V_{CC} = 6.0 \text{ V}; V_{I} = V_{CC} \text{ or GND}; I_{O} = 0 \text{ A}$	-	-	160	μΑ

Table 7. Static characteristics 74HCT154

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbo	Parameter	Conditions	Min	Тур	Max	Unit
T <sub>amb</sub> = 2	25 °C				1	
V <sub>IH</sub>	HIGH-level input voltage	V <sub>CC</sub> = 4.5 V to 5.5 V	2.0	1.6	_	V
V <sub>IL</sub>	LOW-level input voltage	V <sub>CC</sub> = 4.5 V to 5.5 V	-	1.2	0.8	V
V <sub>OH</sub>	HIGH-level output voltage	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>				
		V <sub>CC</sub> = 4.5 V; I <sub>O</sub> = -20 μA	4.4	4.5	-	V
		V <sub>CC</sub> = 4.5 V; I <sub>O</sub> = -4 mA	3.98	4.32	-	V
V <sub>OL</sub>	LOW-level output voltage	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>				
		V <sub>CC</sub> = 4.5 V; I <sub>O</sub> = 20 μA	-	0	0.1	V
		V <sub>CC</sub> = 4.5 V; I <sub>O</sub> = 4 mA	-	0.15	0.25	V
I <sub>I</sub>	input leakage current	$V_{CC}$ = 5.5 V; $V_I$ = $V_{CC}$ or GND	-	-	±0.1	μA
Icc	supply current	$V_{CC} = 5.5 \text{ V}; V_I = V_{CC} \text{ or GND}; I_O = 0 \text{ A}$	-	-	8.0	μA
ΔI <sub>CC</sub>	additional supply current	per input pin; $V_{CC} = 4.5 \text{ V to } 5.5 \text{ V};$ $V_1 = V_{CC} - 2.1 \text{ V}; I_O = 0 \text{ A}$	-	-	360	μΑ
Cı	input capacitance		-	3.5	-	pF
T <sub>amb</sub> =	-40 °C to +85 °C	1	<u> </u>	1	'	
V <sub>IH</sub>	HIGH-level input voltage	V <sub>CC</sub> = 4.5 V to 5.5 V	2.0	-	-	V
V <sub>IL</sub>	LOW-level input voltage	V <sub>CC</sub> = 4.5 V to 5.5 V	-	-	0.8	V
V <sub>OH</sub>	HIGH-level output voltage	$V_I = V_{IH}$ or $V_{IL}$				
		V <sub>CC</sub> = 4.5 V; I <sub>O</sub> = -20 μA	4.4	-	-	V
		V <sub>CC</sub> = 4.5 V; I <sub>O</sub> = -4 mA	3.84	-	-	V
V <sub>OL</sub>	LOW-level output voltage	$V_I = V_{IH}$ or $V_{IL}$				
		V <sub>CC</sub> = 4.5 V; I <sub>O</sub> = 20 μA	-	-	0.1	V
		V <sub>CC</sub> = 4.5 V; I <sub>O</sub> = 4 mA	-	-	0.33	V
lį	input leakage current	$V_{CC}$ = 5.5 V; $V_I$ = $V_{CC}$ or GND	-	-	±1.0	μΑ
Icc	supply current	$V_{CC} = 5.5 \text{ V}; V_I = V_{CC} \text{ or GND}; I_O = 0 \text{ A}$	-	-	80	μA
Δl <sub>CC</sub>	additional supply current	per input pin; $V_{CC} = 4.5 \text{ V to } 5.5 \text{ V};$ $V_{I} = V_{CC} - 2.1 \text{ V}; I_{O} = 0 \text{ A}$	-	-	450	μA
T <sub>amb</sub> =	-40 °C to +125 °C			•		
V <sub>IH</sub>	HIGH-level input voltage	V <sub>CC</sub> = 4.5 V to 5.5 V	2.0	-	-	V
V <sub>IL</sub>	LOW-level input voltage	V <sub>CC</sub> = 4.5 V to 5.5 V	-	-	0.8	V
V <sub>OH</sub>	HIGH-level output voltage	$V_I = V_{IH}$ or $V_{IL}$				
		V <sub>CC</sub> = 4.5 V; I <sub>O</sub> = -20 μA	4.4	-	-	V
		V <sub>CC</sub> = 4.5 V; I <sub>O</sub> = -4 mA	3.7	-	-	V
V <sub>OL</sub>	LOW-level output voltage	$V_I = V_{IH}$ or $V_{IL}$				
		V <sub>CC</sub> = 4.5 V; I <sub>O</sub> = 20 μA	-	-	0.1	V
		V <sub>CC</sub> = 4.5 V; I <sub>O</sub> = 4 mA	-	-	0.4	V
I <sub>I</sub>	input leakage current	$V_{CC}$ = 5.5 V; $V_I$ = $V_{CC}$ or GND	-	-	±1.0	μA
I <sub>CC</sub>	supply current	$V_{CC} = 5.5 \text{ V}; V_{I} = V_{CC} \text{ or GND}; I_{O} = 0 \text{ A}$	-	-	160	μΑ
Δl <sub>CC</sub>	additional supply current	per input pin; $V_{CC} = 4.5 \text{ V to } 5.5 \text{ V};$ $V_1 = V_{CC} - 2.1 \text{ V}; I_0 = 0 \text{ A}$	-	-	490	μΑ

### 10. Dynamic characteristics

#### **Table 8. Dynamic characteristics**

GND (ground = 0 V);  $C_L$  = 50 pF unless otherwise specified; for test circuit, see Fig. 9.

Symbol	Parameter	Conditions			25 °C		-40 °C to	o +85 °C	-40 °C to	Unit	
				Min	Тур	Max	Min	Max	Min	Max	
74HC15	4										
t <sub>pd</sub>	propagation	An to Yn; see Fig. 7	[1]								
	delay	V <sub>CC</sub> = 2.0 V		-	36	150	-	190	-	225	ns
		V <sub>CC</sub> = 4.5 V		-	13	30	-	38	-	45	ns
		V <sub>CC</sub> = 5 V; C <sub>L</sub> = 15 pF		-	11	-	-	-	-	-	ns
		V <sub>CC</sub> = 6.0 V		-	10	26	-	33	-	38	ns
		En to Yn; see Fig. 8									
		V <sub>CC</sub> = 2.0 V		-	39	150	-	190	-	225	ns
		V <sub>CC</sub> = 4.5 V		-	14	30	-	38	-	45	ns
		V <sub>CC</sub> = 5 V; C <sub>L</sub> = 15 pF		-	11	-	-	-	-	-	ns
		V <sub>CC</sub> = 6.0 V		-	11	26	-	33	-	38	ns
t <sub>t</sub>	transition time	see Fig. 7 and Fig. 8	[2]								
		V <sub>CC</sub> = 2.0 V		-	19	75	-	95	-	110	ns
		V <sub>CC</sub> = 4.5 V		-	7	15	-	19	-	22	ns
		V <sub>CC</sub> = 6.0 V		-	6	13	-	16	-	19	ns
C <sub>PD</sub>	power dissipation capacitance	per gate; V <sub>I</sub> = GND to V <sub>CC</sub>	[3]	-	60	-	-	-	-	-	pF
74HCT1	54		,			ı	l		'	'	
t <sub>pd</sub>	propagation	An to <del>Yn</del> ; see <u>Fig. 7</u>	[1]								
	delay	V <sub>CC</sub> = 4.5 V		-	16	35	-	44	-	53	ns
		V <sub>CC</sub> = 5 V; C <sub>L</sub> = 15 pF		-	13	-	-	-	-	-	ns
		En to Yn; see Fig. 8									
		V <sub>CC</sub> = 4.5 V		-	15	32	-	40	-	48	ns
		V <sub>CC</sub> = 5 V; C <sub>L</sub> = 15 pF		-	13	-	-	-	-	-	ns
t <sub>t</sub>	transition time	see Fig. 7 and Fig. 8	[2]								
		V <sub>CC</sub> = 4.5 V		-	7	15	-	19	-	22	ns
C <sub>PD</sub>	power dissipation capacitance	per gate; [3] V <sub>I</sub> = GND to (V <sub>CC</sub> - 1.5 V)		-	60	-	-	-	-	-	pF

 $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}^2 \times f_o)$  where:

f<sub>i</sub> = input frequency in MHz;

fo = output frequency in MHz;

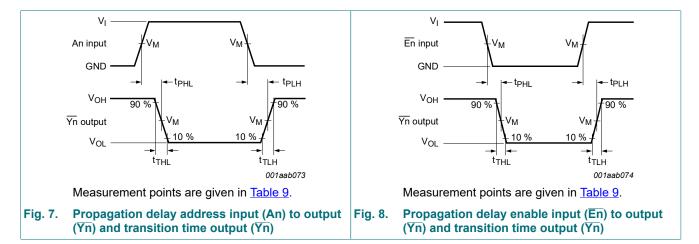
C<sub>L</sub> = output load capacitance in pF;

V<sub>CC</sub> = supply voltage in V;

N = number of load switching outputs;  $\Sigma(C_L \times V_{CC}^2 \times f_o)$  = sum of the outputs.

 $<sup>\</sup>begin{array}{ll} [1] & t_{pd} \text{ is the same as } t_{PLH} \text{ and } t_{PHL} \\ [2] & t_{t} \text{ is the same as } t_{TLH} \text{ and } t_{THL} \\ [3] & C_{PD} \text{ is used to determine the dynamic power dissipation } (P_{D} \text{ in } \mu\text{W}). \end{array}$ 

### 10.1. Waveforms and test circuit



**Table 9. Measurement points** 

Туре	Input	Output
	V <sub>M</sub>	V <sub>M</sub>
74HC154	0.5V <sub>CC</sub>	0.5V <sub>CC</sub>
74HCT154	1.3 V	1.3 V

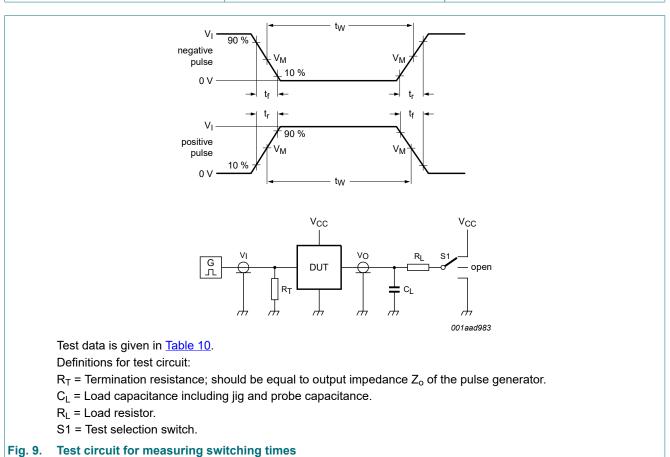
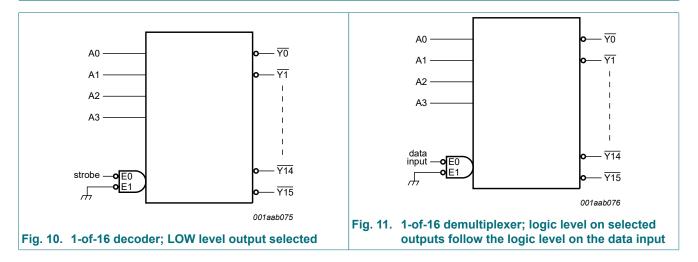


Table 10. Test data

Туре	Input		Load		S1 position
			CL	$R_L$	t <sub>PHL</sub> , t <sub>PLH</sub>
74HC154	V <sub>CC</sub>	6 ns	15 pF, 50 pF	1 kΩ	open
74HCT154	3 V	6 ns	15 pF, 50 pF	1 kΩ	open

### 11. Application information

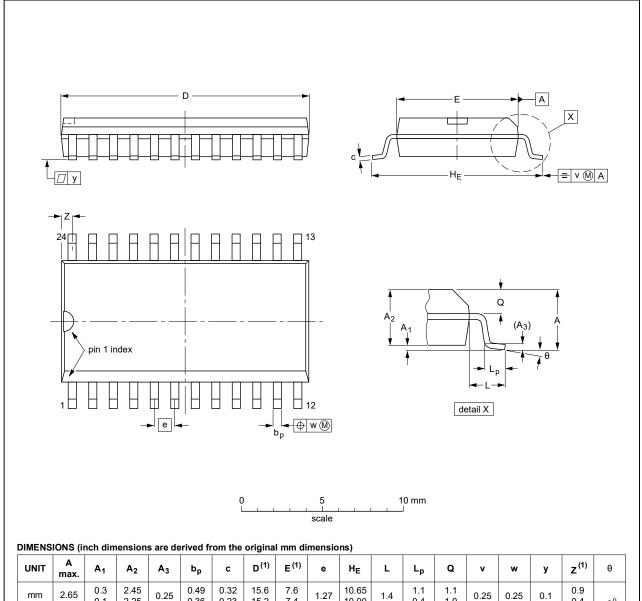


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### 12. Package outline

### SO24: plastic small outline package; 24 leads; body width 7.5 mm

SOT137-1



U	INIT	A max.	<b>A</b> <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	bp	С	D <sup>(1)</sup>	E <sup>(1)</sup>	е	HE	L	Lp	Q	٧	w	у	z <sup>(1)</sup>	θ
r	mm	2.65	0.3 0.1	2.45 2.25	0.25	0.49 0.36	0.32 0.23	15.6 15.2	7.6 7.4	1.27	10.65 10.00	1.4	1.1 0.4	1.1 1.0	0.25	0.25	0.1	0.9 0.4	8°
ine	ches	0.1	0.012 0.004	0.096 0.089	0.01	0.019 0.014	0.013 0.009	0.61 0.60	0.30 0.29	0.05	0.419 0.394	0.055	0.043 0.016	0.043 0.039	0.01	0.01	0.004	0.035 0.016	0°

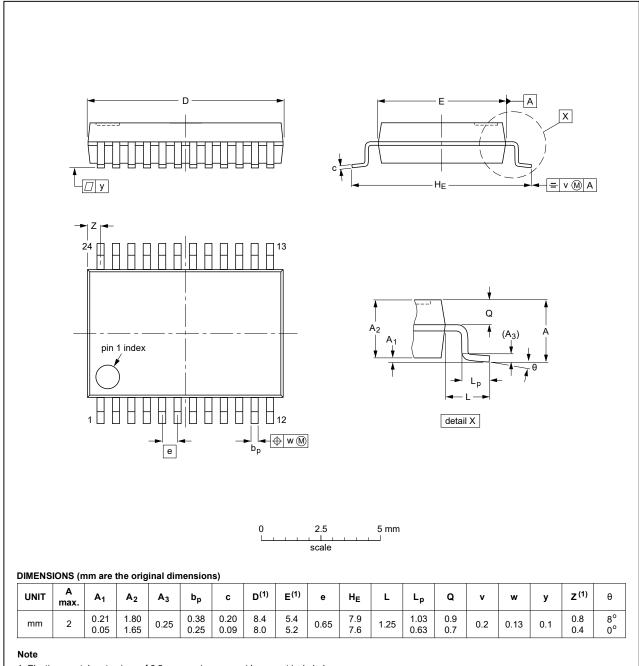
1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

OUTLINE VERSION	REFERENCES			EUROPEAN	ISSUE DATE	
	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT137-1	075E05	MS-013				<del>99-12-27</del> 03-02-19

Fig. 12. Package outline SOT137-1 (SO24)

### SSOP24: plastic shrink small outline package; 24 leads; body width 5.3 mm

SOT340-1



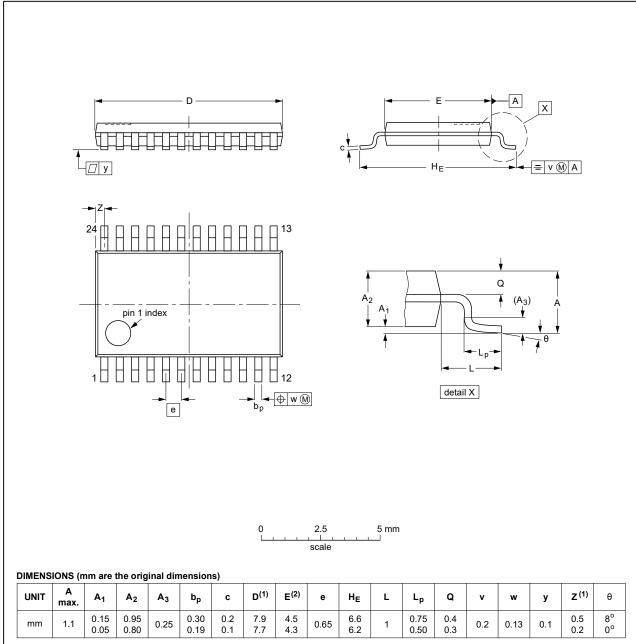
1. Plastic or metal protrusions of 0.2 mm maximum per side are not included.

OUTLINE	REFERENCES			EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT340-1		MO-150			$ \  \   \bigoplus  \big($	<del>99-12-27</del> 03-02-19

Fig. 13. Package outline SOT340-1 (SSOP24)

TSSOP24: plastic thin shrink small outline package; 24 leads; body width 4.4 mm

SOT355-1



#### Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE	REFERENCES			EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT355-1		MO-153				<del>99-12-27</del> 03-02-19

Fig. 14. Package outline SOT355-1 (TSSOP24)

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DHVQFN24: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 24 terminals; body  $3.5 \times 5.5 \times 0.85$  mm

SOT815-1

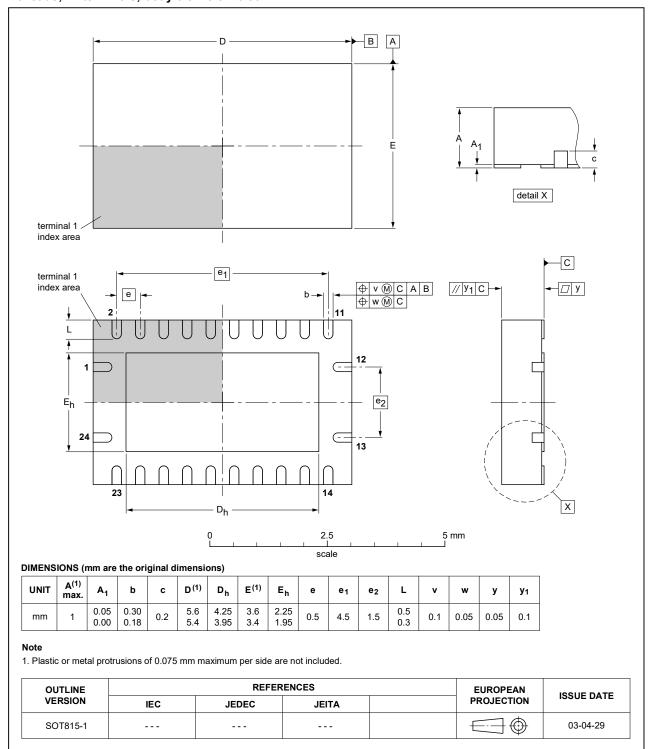


Fig. 15. Package outline SOT815-1 (DHVQFN24)

### 13. Abbreviations

#### **Table 11. Abbreviations**

Acronym	Description	
CMOS	Complementary Metal Oxide Semiconductor	
DUT	Device Under Test	
ESD	ElectroStatic Discharge	
НВМ	Human Body Model	
TTL	Transistor-Transistor Logic	
MM	Machine Model	

## 14. Revision history

### **Table 12. Revision history**

Document ID	Release date	Data sheet status	Change notice	Supersedes			
74HC_HCT154 v.8	20210511	Product data sheet	-	74HC_HCT154 v.7			
Modifications:	guidelines of Legal texts Type number Fig. 5: over	<ul> <li>The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia.</li> <li>Legal texts have been adapted to the new company name where appropriate.</li> <li>Type number 74HCT154DB (SOT340-1 / SSOP24) removed.</li> <li>Fig. 5: overline corrected (errata).</li> <li>Section 7: Derating values for Ptot total power dissipation updated.</li> </ul>					
74HC_HCT154 v.7	20160229	Product data sheet	-	74HC_HCT154 v.6			
Modifications:	Type numbers 74HC154N and 74HCT154N (SOT101-1) removed.						
74HC_HCT154 v.6	20070212	Product data sheet	-	74HC_HCT154 v.5			
Modifications:	guidelines o Legal texts	<ul> <li>The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors.</li> <li>Legal texts have been adapted to the new company name where appropriate.</li> <li>Table 3: Corrected errors in output information.</li> </ul>					
74HC_HCT154 v.5	20041012	Product specification	-	74HC_HCT154 v.4			
74HC_HCT154 v.4	20041005	Product specification	-	74HC_HCT154 v.3			
74HC_HCT154 v.3	20040601	Product specification	-	74HC_HCT154_CNV v.2			

### 15. Legal information

#### **Data sheet status**

Document status [1][2]	Product status [3]	Definition		
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.		
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.		
Product [short] data sheet	Production	This document contains the product specification.		

- Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
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